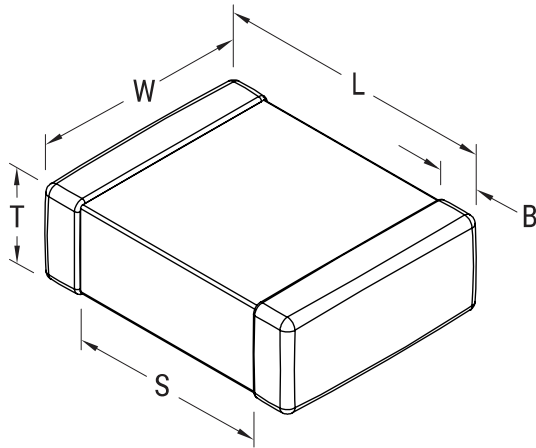




Click [here](#) for the 3D model.

General Information

Series	SMD Comm X7R FO
Style	SMD Chip
Description	SMD, MLCC, Open Mode, Temperature Stable
Features	Open Mode, Temperature Stable
RoHS	Yes
Termination	Tin
Marking	No
Typical Component Weight	7.3 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.039 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	10 VDC
Dielectric Withstanding Voltage	25 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%
Dissipation Factor	5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	25.641 GOhms

Dimensions

L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.15mm
S	0.5mm MIN
B	0.35mm +/-0.15mm
Case Code (EIA / mm)	0603 / 1608

Packaging Specifications

Packaging	T&R, 330mm, Paper Tape
Packaging Quantity	15000

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